



100V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS} (ON) max	I _D max T _A = +25°C
100V	52mΩ @ V _{GS} = 10V	5A
1000	$75m\Omega$ @ V _{GS} = 4.5V	4.1A

Description

This new generation MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Features and Benefits

- 0.6mm Profile Ideal for Low Profile Applications
- PCB Footprint of 4mm²
- Low On-Resistance
- 100% Unclamped Inductive Switching (UIS) Test in Production -Ensures More Reliable and Robust End Application
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at

https://www.diodes.com/products/automotive/automotiveproducts/.

This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability. https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: U-DFN2020-6
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.0065 grams (Approximate)

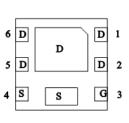
Applications

- **Power Management Functions**
- Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Memories, Transistors, etc.

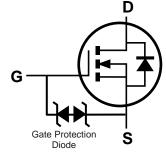












Equivalent Circuit

Ordering Information (Note 4)

Part Number	Case	Quantity Per Reel
DMT10H052LFDF-7	U-DFN2020-6 (Type F)	3,000
DMT10H052LFDF-13	U-DFN2020-6 (Type F)	10,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/



Marking Information

U-DFN2020-6 (Type F)



57 = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 0 = 2020)

W = Week (ex: a = week 27; z represents week 52 and 53)

X = Internal Code (ex: U = Monday)

Date Code Key

- 410 0040 . 10,												
Year	2019	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	9	0	1	2	3	4	5	6	7	8	9	0
Week	Week 1-26 27-52 53											
			-20		27-52				უა			
Code		A	<u>Z</u>		a-z			Z				
Internal Code	Sur	1	Mon		Tue	W	ed	Thu		Fri		Sat
Code	Т		U		V	\	٧	Х		Υ		Z

Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		VDSS	100	V
Gate-Source Voltage	Vgss	±20	V	
Continuous Drain Current, V _{GS} = 10V (Note 6)	lo	5 4	А	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	Ірм	30	Α	
Maximum Body Diode Continuous Current	Is	2.3	Α	
Pulsed Body Diode Continuous Current (10µs Pulse, Duty	Ism	30	Α	
Avalanche Current, L = 0.1mH (Note 7)	I _{AS}	15.6	Α	
Avalanche Energy, L = 0.1mH (Note 7)	Eas	12.2	mJ	

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Total Dowar Discination (Note 5)	$T_A = +25^{\circ}C$	D-	0.8	W	
Total Power Dissipation (Note 5)	$T_A = +70$ °C	P _D	0.5	VV	
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	151	°C/W		
Total Dawer Dissipation (Note 6)	T _A = +25°C	D-	1.9	W	
Total Power Dissipation (Note 6)	$T_A = +70$ °C	PD	1.2	VV	
Thermal Resistance, Junction to Ambient (Note 6)	R _θ JA	64	°C/W		
Thermal Resistance, Junction to Case (Note 6)	R ₀ JC	11	C/VV		
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C		

Notes:

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
- 7. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.

DMT10H052LFDF Datasheet number: DS41699 Rev. 3 - 2



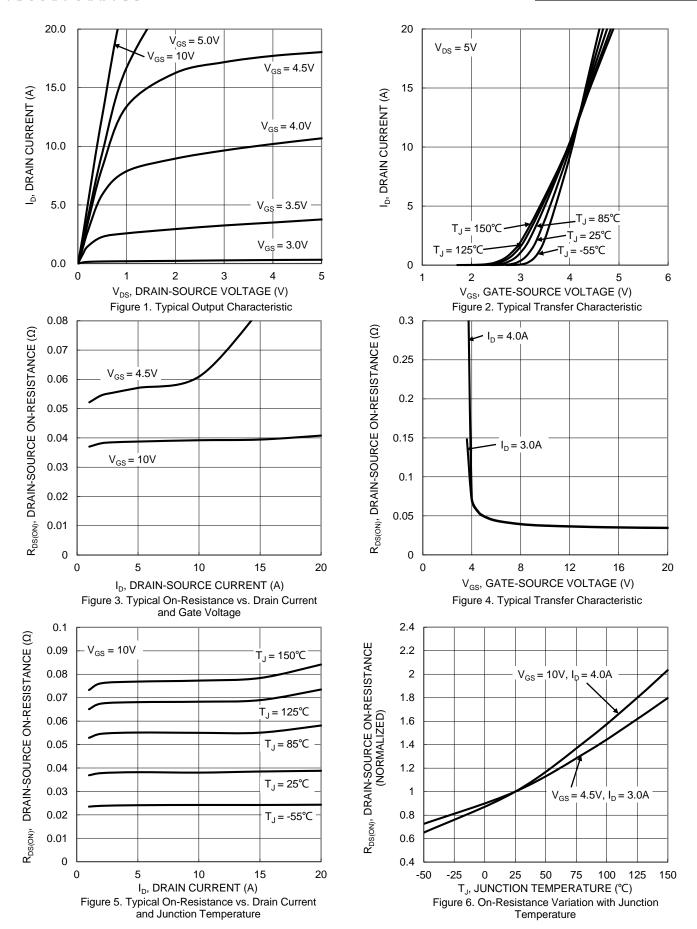
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV _{DSS}	100		_	V	$V_{GS} = 0V$, $I_D = 1mA$
Zero Gate Voltage Drain Current	IDSS		1	1	μΑ	V _{DS} = 80V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	_	_	±10	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	Vgs(TH)	1.5	1	3.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
Static Drain-Source On-Resistance	D-s(s)		38	52	mΩ	$V_{GS} = 10V$, $I_D = 4A$
Static Dialif-Source Off-Resistance	Rds(on)		54	75	11122	$V_{GS} = 4.5V, I_{D} = 3A$
Diode Forward Voltage	V _{SD}	_	0.8	1.0	V	$V_{GS} = 0V, I_{S} = 1A$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	Ciss		258	_	рF), 50\/\), 0\/
Output Capacitance	Coss	l	114		рF	V _{DS} = 50V, V _{GS} = 0V, f = 1MHz
Reverse Transfer Capacitance	Crss	-	5.5	_	pF	1 – 1101112
Gate Resistance	Rg	_	6.3	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (VGS = 4.5V)	Qg	-	2.9	_	nC	
Total Gate Charge (V _{GS} = 10V)	Qg	_	5.4	_	nC	\/ 50\/ I- 4A
Gate-Source Charge	Q _{gs}	_	0.8	_	nC	$V_{DS} = 50V, I_{D} = 4A$
Gate-Drain Charge	Qgd	_	1.6	_	nC	
Turn-On Delay Time	t _{D(ON)}	_	3.1	_	ns	
Turn-On Rise Time	t _R	_	3.8	_	ns	$V_{DS} = 50V$, $R_L = 11\Omega$
Turn-Off Delay Time	tD(OFF)	_	11.4	_	ns	$V_{GS} = 10V, R_{GEN} = 3\Omega$
Turn-Off Fall Time	tF	_	4.4	_	ns]
Reverse Recovery Time	trr	_	22.6	_	ns	1 4A 11/11 000A/c-
Reverse Recovery Charge	Q _{RR}		43.6	_	nC	IF = 4A, di/dt = 300A/μs

Notes:

^{8.} Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to product testing.







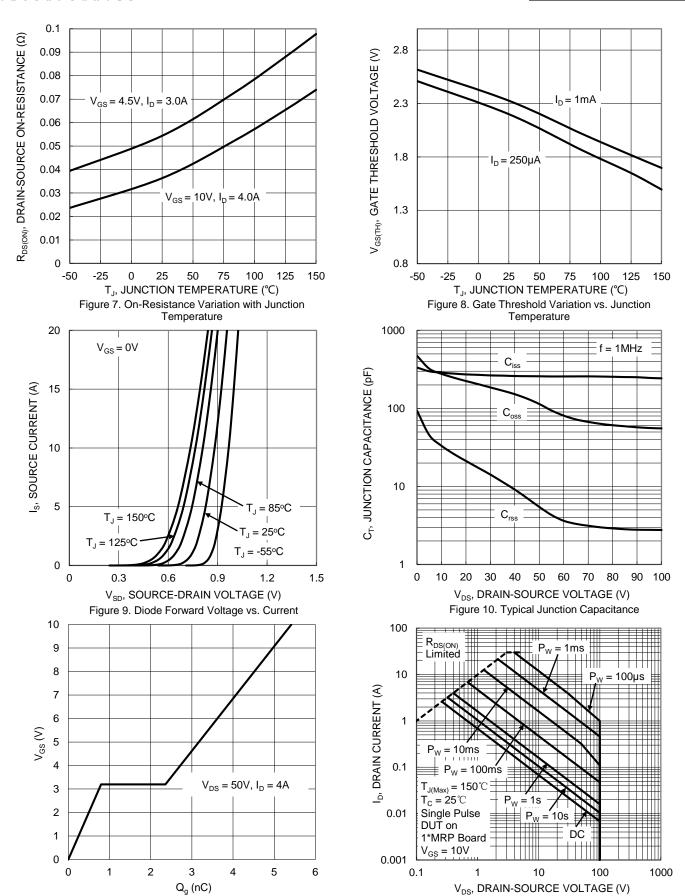


Figure 11. Gate Charge

Figure 12. SOA, Safe Operation Area



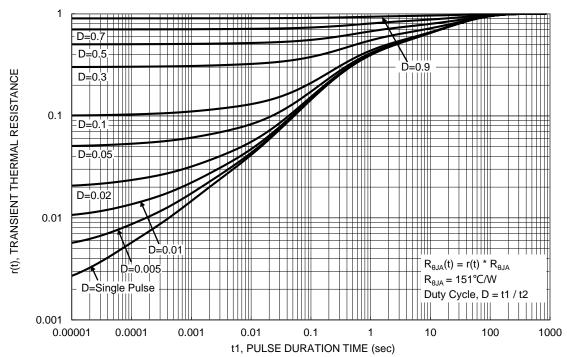


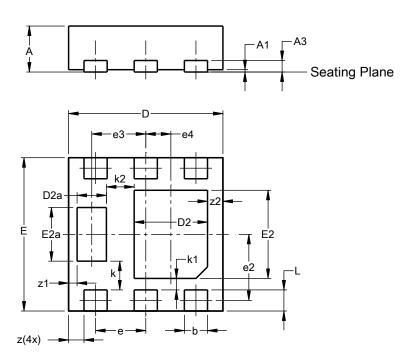
Figure 13. Transient Thermal Resistance



Package Outline Dimension

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type F)

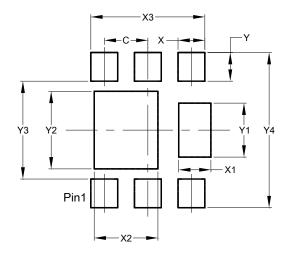


U-DFN2020-6							
(Type F)							
Dim	Min	Max	Тур				
Α	0.57	0.63	0.60				
A1	0.00	0.05	0.03				
A3	-	-	0.15				
b	0.25	0.35	0.30				
D	1.95	2.05	2.00				
D2	0.85	1.05	0.95				
D2a	0.33	0.43	0.38				
Е	1.95	2.05	2.00				
E2	1.05	1.25	1.15				
E2a	0.65	0.75	0.70				
е		0.65 BSC					
e2	C).863 BS	SC				
е3		0.70 BS	С				
e4	C).325 BS	SC				
k	0.37 BSC						
k1	0.15 BSC						
k2	0.36 BSC						
L	0.225 0.325 0.275						
Z	0.20 BSC						
z1	0.110 BSC						
z2	0.20 BSC						
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type F)



Dimensions	Value (in mm)		
Dimensions			
C	0.650		
X	0.400		
X1	0.480		
X2	0.950		
Х3	1.700		
Y	0.425		
Y1	0.800		
Y2	1.150		
Y3	1.450		
Y4	2.300		



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